

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

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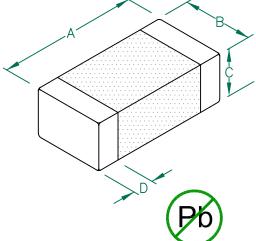
PHYSICAL DIMENSIONS:

LI1206H151R-10

UNCONTROLLED DOCUMENT

C 1.10 [.043] ± 0.20 [.008]

D 0.51 [.020] ± 0.25 [.010]

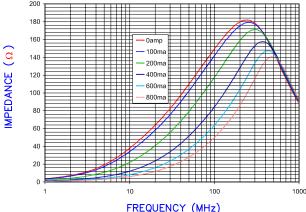


ELECTRICAL CHARACTERISTICS:										
Z @ 100M (Ω)	1Hz	DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current							
Nominal	150									
Minimum	113									
Maximum	188	0.15	800 mA							

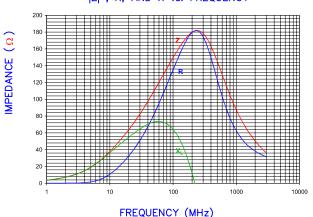
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS



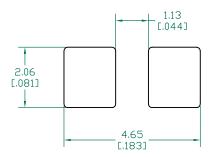
|Z| , R, AND X vs. FREQUENCY



 X_{I}

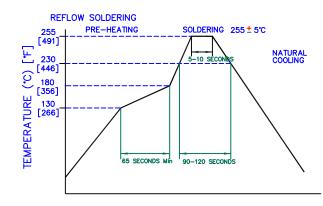
AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3298

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (.030) to this dimension)

RECOMMENDED SOLDERING CONDITIONS



	DIMENSIONS ARE IN mm [INCHES].				This print is the property of Laird					
					Tech, and is loaned in confidence subject to return upon request ar	.al	Laird			
					with the understanding that no	٠ ١				
					copies shall be made without the	Land				
					written consent of Laird Tech. All rights to design or invention are	_				
					reserved.					
	D	D ADD OPERATING TEMPERATURE		QU	PROJECT/PART NUMBER:	REV	PART TYPE:	;	DRAWN BY:	
		UPDATE LAIRD LOGO AND REFLOW CURVE			LI1206H151R-10	D	CO-FI	RF	тмв	
	С		07/22/08			_	00 11		111112	
	В	CORRECT REF # FROM 3289 TO 3298	07/22/05	JRK	DATE: 04/05/04 SC	ALE: N	ITS S	SHEET:		
	Α	ORIGINAL DRAFT	04/05/04	TMB	CAD 4	OL #		2	of 2	
	REV	DESCRIPTION	DATE	INT	100 LI1206H151R-10-D	"	-	_	· -	

